

SWITCHMODE [™] **Series NPN Silicon Power Transistor**

... designed for high speed, high current, high power applications.

• High DC current gain:

$$h_{FE}$$
 min. = 20 at I_{C} = 12 A

• Low V_{CE(sat)}, V_{CE(sat)}

max. =
$$0.6 \text{ V}$$
 at $I_C = 8 \text{ A}$

• Very fast switching times:

TF max. =
$$0.4 \mu s$$
 at $I_C = 25 A$

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO(sus)}	200	Vdc
Collector-Base Voltage	V _{CBO}	250	Vdc
Emitter-Base Voltage	V _{EBO}	7	Vdc
Collector–Emitter Voltage (V _{BE} = -1.5 V)	V _{CEX}	250	Vdc
Collector–Emitter Voltage ($R_{BE} = 100 \Omega$)	V _{CER}	240	Vdc
Collector–Current — Continuous — Peak (PW ≤ 10 ms)	I _C I _{CM}	40 50	Adc Apk
Base-Current continuous	I _B	8	Adc
Total Power Dissipation @ T _C = 25°C	P _D	250	Watts
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-65 to 200	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θ_{JC}	0.7	°C/W

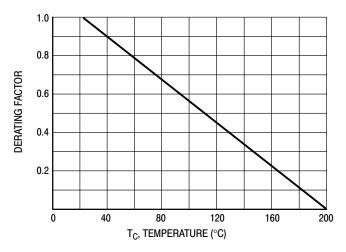


Figure 1. Power Derating

BUV21

40 AMPERES
NPN SILICON
POWER
METAL TRANSISTOR
200 VOLTS
250 WATTS



CASE 197A-05 TO-204AE (TO-3)

BUV21

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit	
OFF CHARACTERISTICS ¹						
Collector–Emitter Sustaining Vol (I _C = 200 mA, I _B = 0, L = 25 m	· ·	V _{CEO(sus)}	200		Vdc	
Collector Cutoff Current at Reverse Bias: $(V_{CE} = 250 \text{ V}, V_{BE} = -1.5 \text{ V})$ $(V_{CE} = 250 \text{ V}, V_{BE} = -1.5 \text{ V}, T_{C} = 125^{\circ}\text{C})$		I _{CEX}		3.0 12.0	mAdc	
Collector–Emitter Cutoff Current (V _{CE} = 160 V)		I _{CEO}		3.0	mAdc	
Emitter-Base Reverse Voltage (I _E = 50 mA)		V _{EBO}	7		V	
Emitter–Cutoff Current (V _{EB} = 5 V)		I _{EBO}		1.0	mAdc	
SECOND BREAKDOWN			•	•	•	
Second Breakdown Collector Current with base forward biased (V _{CE} = 20 V, t = 1 s) (V _{CE} = 140 V, t = 1 s)		I _{S/b}	12 0.15		Adc	
ON CHARACTERISTICS ¹		•	<u> </u>	•	1	
DC Current Gain (I _C = 12 A, V _{CE} = 2 V) (I _C = 25 A, V _{CE} = 4 V)		h _{FE}	20 10	60		
Collector–Emitter Saturation Voltage (I _C = 12 A, I _B = 1.2 A) (I _C = 25 A, I _B = 3 A)		V _{CE(sat)}		0.6 1.5	Vdc	
Base–Emitter Saturation Voltage (I _C = 25 A, I _B = 3 A)		V _{BE(sat)}		1.5	Vdc	
DYNAMIC CHARACTERISTICS		1	l .		1	
Current Gain – Bandwidth Product (V _{CE} = 15 V, I _C = 2 A, f = 4 MHz)		f _T	8.0		MHz	
SWITCHING CHARACTERISTIC	S (Resistive Load)	•	•	•	•	
Turn-on Time		t _{on}		1.0	μs	
Storage Time	$(I_C = 25 \text{ A}, I_{B1} = I_{B2} = 3 \text{ A}, V_{CC} = 100 \text{ V}, R_C = 4 \Omega)$	t _s		1.8		
Fall Time	100 100 1,110 - 1 110	t _f		0.4		

¹ Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2\%$.

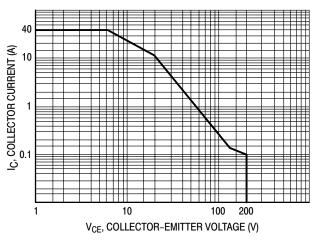


Figure 2. Active Region Safe Operating Area

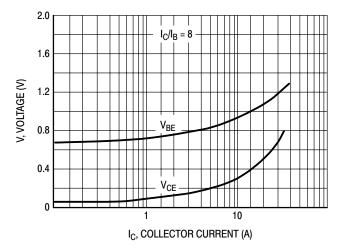


Figure 3. "On" Voltages

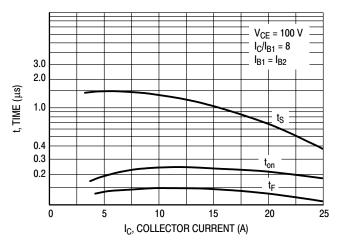


Figure 5. Resistive Switching Performance

There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 2 is based on $T_C = 25^{\circ}C$, $T_{J(pk)}$ is variable depending on power level. Second breakdown limitations do not derate the same as thermal limitations.

At high case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown.

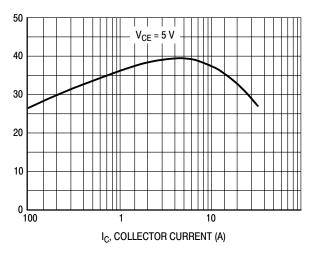
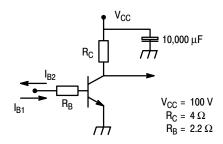


Figure 4. DC Current Gain



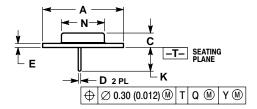
R_C - R_B: Non inductive resistances

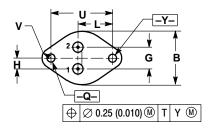
Figure 6. Switching Times Test Circuit

BUV21

PACKAGE DIMENSIONS

TO-204 (TO-3) CASE 197A-05 **ISSUE J**





NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH

	INCHES MILLIMETERS			ETEDS	
DIM		MAX			
DIM	MIN		MIN	MAX	
Α	1.530 REF		38.86 REF		
В	0.990	1.050	25.15	26.67	
С	0.250	0.335	6.35	8.51	
D	0.057	0.063	1.45	1.60	
E	0.060	0.070	1.53	1.77	
G	0.430 BSC		10.92 BSC		
Н	0.215	BSC	5.46 BSC		
K	0.440	0.480	11.18	12.19	
٦	0.665	BSC	16.89 BSC		
N	0.760	0.830	19.31	21.08	
Q	0.151	0.165	3.84	4.19	
U	1.187 BSC		30.15 BSC		
٧	0.131	0.188	3.33	4.77	

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